

DESCRIPTION:

The products are Darlington transistor opto-couplers in a plastic SOP4 package. The device combines an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector. With the robust coplanar double mold structure, the device provides the most stable isolation feature. The products are widely used in switch mode power supplies, programmable controllers, household appliances and office equipment.

MAIN FEATURES

High isolation 3750 VRMS

Operating temperature range -55°C to 110°C

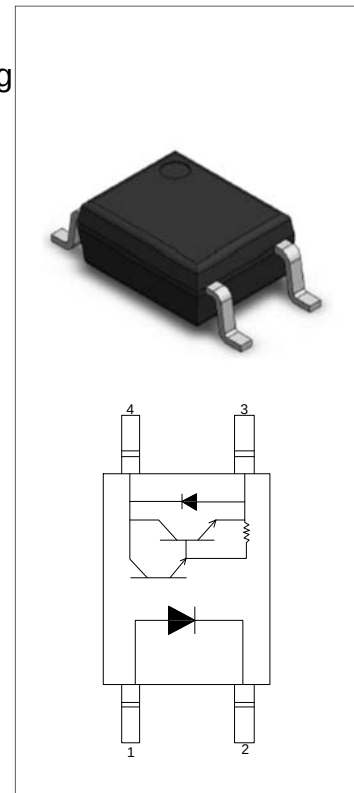
RoHS & REACH Compliance

HBM: H3A; MM: M4; CDM: C3

CQC approved

VDE approved

UL approved



ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Input	Forward Current	I_F	50	mA
	Peak Forward Current	I_{FP}	1	A
	Reverse Voltage	V_R	6	V
	Power Dissipation	P_D	75	mW
Output	Collector-emitter Voltage	V_{CEO}	300	V
	Emitter-collector Voltage	V_{ECO}	0.3	V
	Collector Current	I_C	150	mA
	Power Dissipation	P_C	150	mW
Total Power Dissipation		P_{tot}	225	mW
Isolation Voltage		V_{iso}	3750	Vrms
Operating Temperature		T_{opr}	-55~+110	
Junction Temperature		T_j	125	



Storage Temperature	T_{stg}	-55~+125	
Soldering Temperature	T_{sol}	260	

NOTE1: 100μs pulse, 100Hz frequency

NOTE2: AC for 1minute, R.H.=40~60%

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

	Forward Voltage	V_F	$I_F=10\text{mA}$	-	1.2	1.5	V
Input	Reverse Current	I_R					



ORDERING INFORMATION

J	OC	T	352	J	-M4	/
JieJie Microelectronics Co., Ltd.	Opto Coupler	Darlington Transistor	Marketization Model	CTR Rank:J/K/L	SOP4	None:T1 R:T2

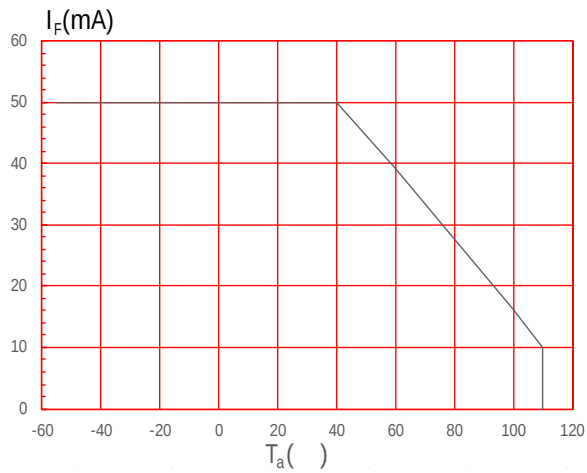
Packing Quantity			
Option	Quantity	Quantity – Inner box	Quantity –Outer box
SOP4	3000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box =30k Units

MARKING

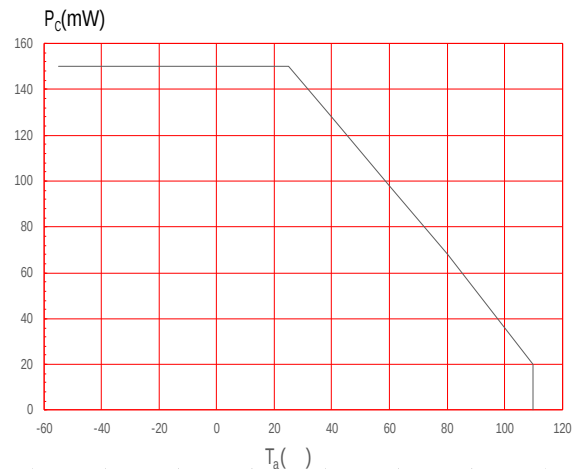


Characteristics Curves

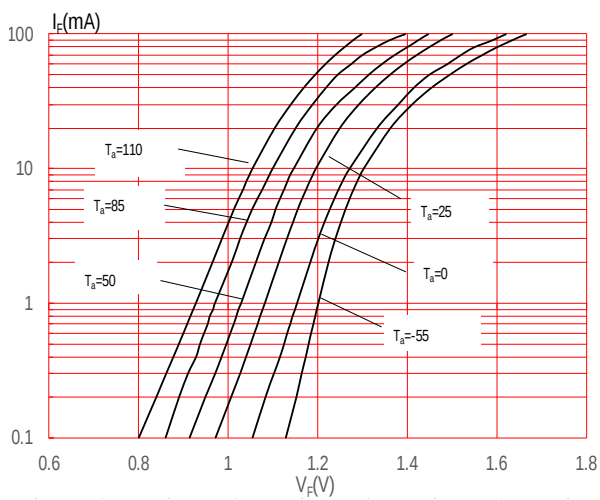
Max. Allowable LED Forward Current vs. Ambient Temperature



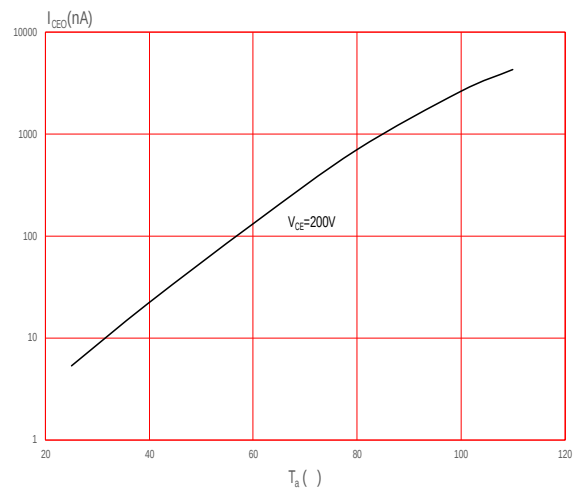
Collector Power Dissipation vs. Ambient Temperature



Forward Current vs. Forward Voltage

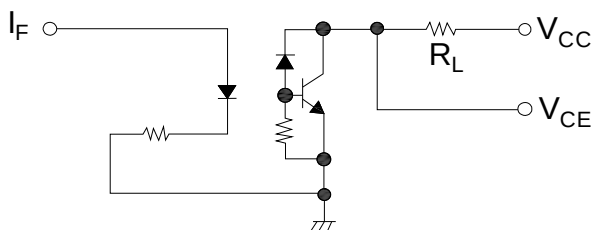


Collector Dark Current vs. Ambient Temperature

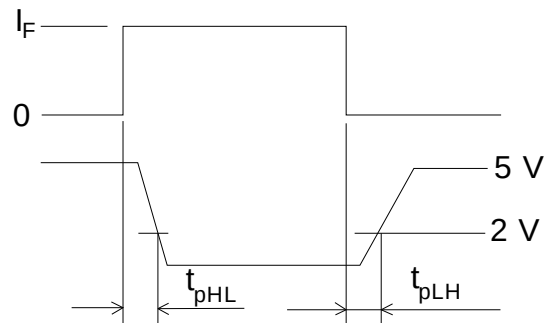


Test Circuits

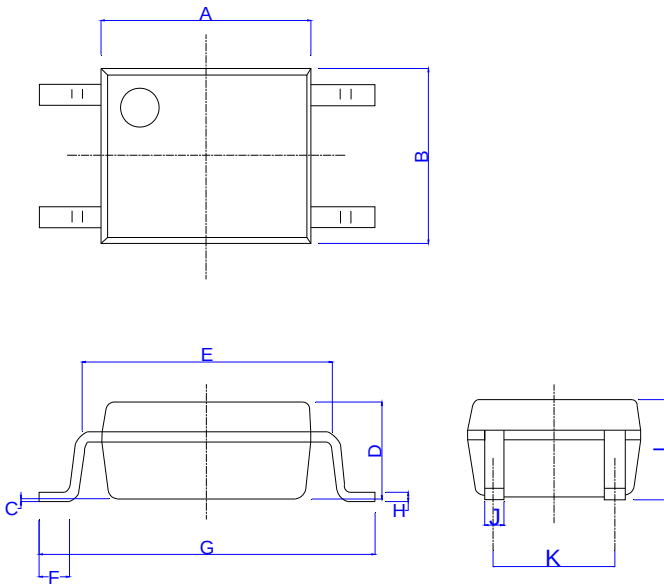
Test Circuits of Propagation Delay Time



Curves of Propagation Delay Time

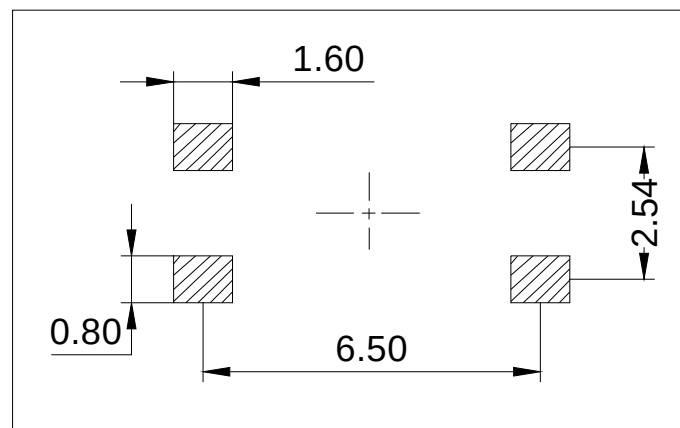


Package Dimension (Unit: mm)



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.80	0.173		0.189
B	3.60		4.20	0.142		0.165
C	0.00		0.20	0.000		0.008
D	1.90		2.30	0.075		0.091
E	5.00		5.60	0.197		0.220
F	0.34		0.94	0.013		0.037
G	6.70		7.30	0.264		0.287
H	0.10		0.30	0.004		0.012
I	2.00		2.40	0.079		0.094
J	0.25		0.55	0.010		0.022
K	2.29		2.79	0.090		0.110

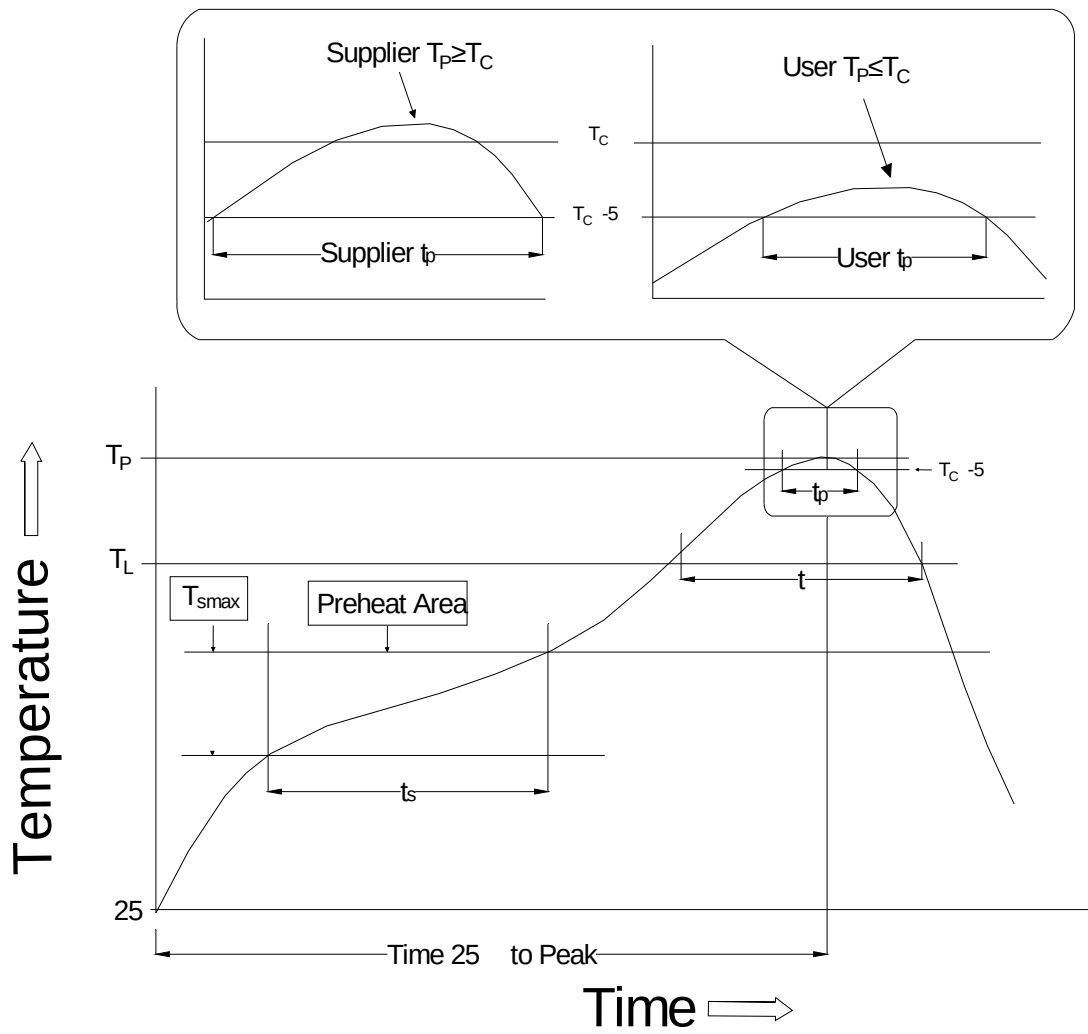
RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)







REFLOW INFORMATION





Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;
Recommend storage humidity: <60%;
MSL level: MSL 1

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